



# Product Change Notification

## 108866 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108866 - 01  
**Change Title:** DG31GL, PCN 108866-01, Product Material, IO Shield vendor change and MCH heatsink change, Reason for Revision: Adding MCH heatsink change and implementation date changed.  
**Date of Publication:** October 17, 2008

**Key Characteristics of the Change:**  
Product Material

**Forecasted Key Milestones:**

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Nov 06, 2008
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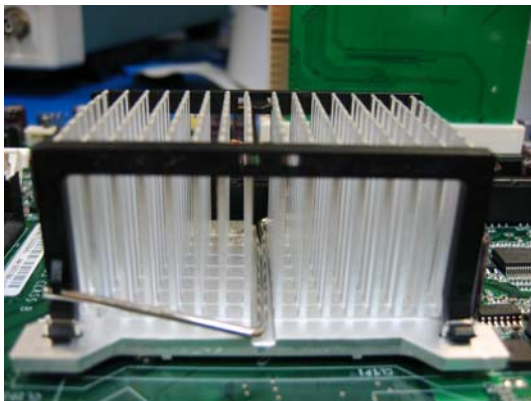
**Description of Change to the Customer:**

**Reason for Revision:** Adding MCH heatsink change and implementation date changed.

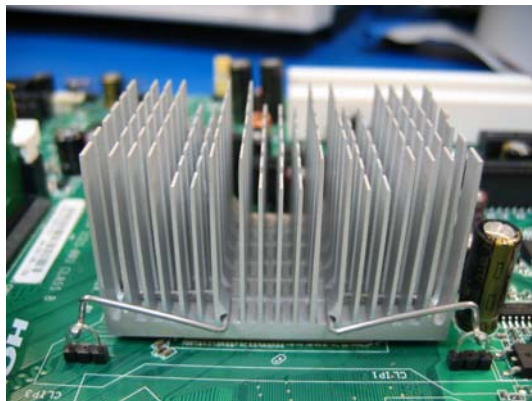
The IO shield vendor is being changed.

The heatsink for MCH is being changed to a new version to enhance manufacturability.

Existing Heatsink



New Heatsink



### Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

### Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change AA	Post Change AA
BOXDG31GL 897041	897041	E33912-200	E33912-201
BLKDG31GL 897042	897042	E33912-200	E33912-201
LADG31GL 897045	897045	E33911-200	E33911-201

### PCN Revision History:

**Date of Revision:**

October 7, 2008

October 17, 2008

**Revision Number:**

00

01

**Reason:**

Originally Published PCN

Adding MCH heatsink change and implementation date changed.